530745-3 - ACTIVE

AMP

TE Internal #: 530745-3 PCB Mount Receptacle, Vertical, Board-to-Board, 40 Position, .05 in [1.27 mm] Centerline, Gold, Through Hole - Solder, Power & Signal, Gray

Connectors > PCB Connectors > PCB Headers & Receptacles

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PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 40

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

= TEconnectivity

PCB Mount Receptacle

Board-to-Board

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	No
PCB Mount Orientation	Vertical
Number of Positions	40
Number of Rows	2
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	600 VAC
Body Features	
Primary Product Color	Gray
Contact Features	
Contact Layout	Staggered
Mating Square Post Dimension	.46 mm[.018 in]
PCB Contact Termination Area Plating Material	Tin-Lead

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Contact Base Material	Beryllium Copper
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	1.27 μm[50 μin]
Contact Type	Socket
Contact Current Rating (Max)	1.5 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.46 mm[.018 in]
Termination Post & Tail Length	3.56 mm, 4.83 mm[.14 in][.19 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	With
Mating Alignment Type	Keyed
PCB Mount Retention	Without
PCB Mount Alignment	With
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	1.27 mm[.05 in]
Housing Material	LCP (Liquid Crystal Polymer)
Dimensions	
Connector Height	5.46 mm[.215 in]
Row-to-Row Spacing	3.81 mm[.15 in]
Stack Height	15.24 mm[.6 in]
PCB Thickness (Recommended)	.05 – .07 mm[.054 – .07 in]
Jsage Conditions	
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Assembly Process Feature	None
Circuit Application	Power & Signal
ndustry Standards	
UL Flammability Rating	UL 94V-0

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Circuit Application	Power & Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	

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Packaging Quantity	6
Packaging Type	Package
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2019 (197) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Not Yet Reviewed for halogen content
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

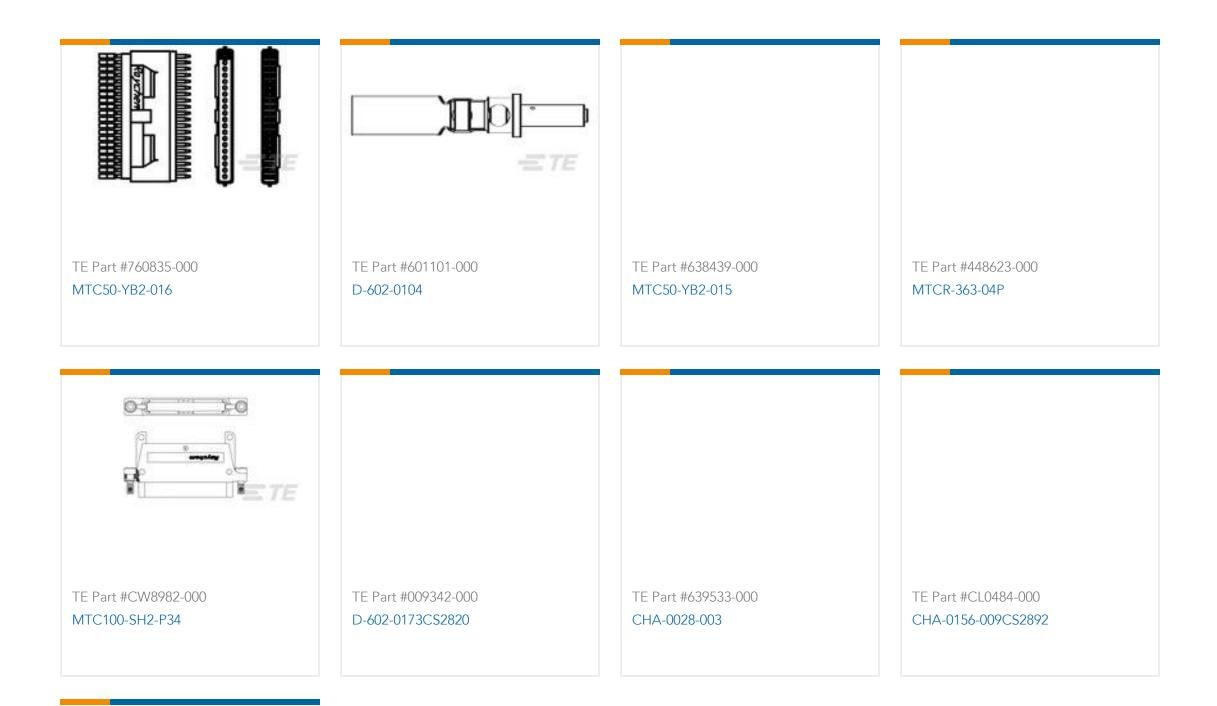
Compatible Parts



Customers Also Bought

PCB Mount Receptacle, Vertical, Board-to-Board, 40 Position, .05 in [1.27 mm] Centerline, Gold, Through Hole - Solder, Power & Signal, Gray







Documents

Product Drawings MINI-BOX RCPT ASSY 40P UNSEAL

English

CAD Files 3D PDF

3D

Customer View Model ENG_CVM_CVM_530745-3_AC.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_530745-3_AC.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_530745-3_AC.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

C For support call+1 800 522 6752

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Products for Aerospace and Defense

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